Overview

HP ProBook 450 G6 Notebook PC



Left

- 1. Internal microphones (2)
- 2. Webcam
- 3. Webcam LED
- 4. Clickpad
- 5. Hard drive LED

- 6. SD card reader
- 7. Thermal vent
- 8. USB 2.0 port
- 9. Security lock slot (Lock sold separately)
- 10. Power button



Overview



Right

- 1. Power connector
- 2. USB Type-C[™] 3.1 Gen 1 port
- 3. Ethernet port (RJ-45)
- 4. HDMI port (Cable not included)

- 5. USB 3.1 Gen 1 port
- 6. USB 3.1 Gen 1 port
- 7. Headphone/microphone combo jack
- 8. HP Fingerprint Sensor



Overview

At a Glance

- Preinstall with Windows 10 versions or FreeDOS 3.0
- Choice of 8th Generation Intel® Core™ i7, i5, i3 processors
- Display include your choice of 39.62 cm (15.6") diagonal HD, Ultra Wide Viewing Angle FHD, Touch or Non-Touch
- Optional Nvidia GeForce MX130 with 2 GB GDDR5 dedicated video memory or integrated Intel® HD Graphics 610 or Intel® UHD 620
- Enhanced security features including TPM2.0, HP BIOSphere, Hardware enforced Firmware Protection, optional Fingerprint sensor, and optional IR camera
- Designed to pass MIL-STD 810G testing.¹
- Weight starting at 4.41 lbs (2.0 kgs)
- HP Long-Life Rechargeable battery, with HP Fast Charge Technology recharges 50% in 30 minutes²
- Supports wireless LAN and wireless WWAN options for connectivity on the go
- Up to 512 GB Solid State Drives and 1 TB Hard Drive
- Up to 32 GB total system memory
- 720p HD webcam, IR camera for face authentication with Windows Hello
- Spill-resistant and optional backlit Keyboard, and Clickpad with multi-touch gestures enabled, taps enabled as default.
- MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.
- 2. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAMES

HP ProBook 450 G6 Notebook PC

OPERATING SYSTEMS

Preinstalled Windows 10 Pro 64¹

Windows 10 Pro 64 (National Academic only)2

Windows 10 Home 641

Windows 10 Home Single Language 64¹ Windows 10 China Government Edition

FreeDOS 3.0

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

PROCESSORS

Intel® Core™ i7-8565U processor with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6}

Intel® Core™ i5-8265U with Intel® UHD Graphics 620 Graphics (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores) 3,4,5,6

Intel® Core™ i3-8145U with Intel® UHD Graphics 620 Graphics (2.1 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 4 MB L3 cache, 2 cores) 3,4,5,6

Intel® Core™ i7+ 8565U processor (Core™ i7 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6,7}

Intel® Core™ i5+ 8265U processor (Core™ i5 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores) 3,4,5,6,7

Processors Family

8th Generation Intel® Core™ i7 processor (i7-8565U) ⁶ 8th Generation Intel® Core™ i5 processor (i5-8265U) ⁶ 8th Generation Intel® Core™ i3 processor (i3-8145U) ⁶

and/or naming is not a measurement of higher performance.

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.
- NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating
 system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8
 or Windows 7 drivers on http://www.support.hp.com.



Technical Specifications

7. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system and requires configuration with an optional Intel® Core™ i(5 or 7)+ processor.

CHIPSET

Integrated with processor

GRAPHICS

Integrated

Intel® UHD graphics 6208

Discrete

NVIDIA® GeForce® MX130 (2 GB DDR5 dedicated)9

Supports

Support HD decode, DX12, HDMI 1.4b up to 4K 30Hz Support CUDA, Optimus, PhysX, GPU Boost 2.0

- 8. HD content required to view HD images.
- 9. Integrated graphics depends on processor. NVIDIA® Optimus™ technology requires an Intel processor, plus an NVIDIA® GeForce® discrete graphics configuration and is available on Windows 10 Pro OS. With NVIDIA® Optimus™ technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be).

DISPLAYS

Internal

Non-Touch

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m 2 , 67% sRGB for two WLAN antennas (1366 x 768) 8,10

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m 2 , 67% sRGB for HD camera and one WLAN antenna (1366 x 768) 8,10

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m 2 , 67% sRGB for HD camera and two WLAN antennas (1366 x 768) 8,10

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD+IR camera and two WLAN antennas (1366 x 768)8,10

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED-backlit slim, 220 cd/m 2 , 67% sRGB for HD camera, WWAN and two WLAN antennas (1366 x 768) 8,10

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m 2 , 67% sRGB for two WLAN antennas (1920 x 1080) 8,10

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m 2 , 67% sRGB for HD camera and one WLAN antenna (1920 x 1080) 8,10

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD camera and two WLAN antennas (1920 x 1080)^{8,10}

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m 2 , 67% sRGB for HD+IR camera and two WLAN antennas (1920 x 1080) 8,10

39.6 cm (15.6") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m 2 , 67% sRGB for HD camera, WWAN and two WLAN antennas (1920 x 1080) 8,10



Technical Specifications

Touch

39.6 cm (15.6") diagonal HD SVA eDP LED-backlit slim touch screen, 220 cd/m 2 , 67% sRGB for HD camera and two WLAN antennas (1366 x 768) 8,10,11

39.6 cm (15.6") diagonal HD SVA eDP LED-backlit slim touch screen, 220 cd/m 2 , 67% sRGB for HD camera, WWAN and two WLAN antennas (1366 x 768) 8,10,11

HDMI

Supports resolutions up to 4K 30Hz

8. HD content required to view HD images.

10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

11. Sold separately or as an optional feature.

Docking station model	Total number of supported displays (incl. the notebook display)	Max. resolutions supported	Dock Connect3ors	Technical limitations
HP UltraSlim Docking Station	3	Dual 2.5K @ 60Hz	2xDP, 1xVGA	Dual 2.5k only with both displays into DP
HP Thunderbolt Dock 120W G2	3	Dual 4k @60Hz	2xDP, 1xVGA, 1xTB,1xUSB-C alt- mode	Dual 4k only with one display in to DP and + TB port or USB-C alt mode + TB port
HP USB-C Dock G4	3	Dual 2K @ 60Hz Single 4K @ 60Hz (3840 x 1440)	1xHDMI, 2xDP	
HP USB-C Universal Dock	3	Dual 4K @ 60Hz Single 5K @ 60Hz	2xDP	
HP USB-C Travel Dock	2	Single 2K @ 60Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time
HP USB-C Mini Dock	2	Single 4K @ 30Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time

STORAGE AND DRIVES

Primary Storage

1 TB 5400 rpm SATA¹² 500 GB 7200 rpm SATA¹²

Primary M.2 Storage

128 GB M.2 SATA TLC Solid State Drive¹²
256 GB PCIe® NVMe™ M.2 Value Solid State Drive¹²
512 PCIe® NVMe™ M.2 TLC Solid State Drive¹²



Technical Specifications

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

Note: PCIe SSD not available for Celeron

MEMORY

Maximum Memory

32 GB DDR4-2400 SDRAM13

Memory

32 GB DDR4-2400 SDRAM (2 X 16 GB)¹³
16 GB DDR4- 2400 SDRAM (1 X 16 GB)
16 GB DDR4- 2400 SDRAM (2 X 8 GB)¹³
12 GB DDR4- 2400 SDRAM (4 GB and 8 GB (1 x 8 GB)¹³
8 GB DDR4- 2400 SDRAM (1 x 8 GB)
8 GB DDR4- 2400 SDRAM (2 x 4 GB)¹³
4 GB DDR4- 2400 SDRAM (1 x 4 GB)

Memory Slots

2 SODIMM Both slots are customer accessible / upgradeable DDR4 PC4 SODIMMS, system runs at 2400 Supports Dual Channel Memory

13. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) WLAN and Bluetooth® 5 Combo, non-vPro™14 Realtek RTL8821CE 802.11ac (1x1) WLAN + Bluetooth® 4.2 Combo¹⁴ Realtek RTL8822BE 802.11ac (2x2) WLAN + Bluetooth® 4.2 Combo¹⁴

WWAN

Intel® XMM™ 7262 LTE-Advanced (Cat6)¹⁵
Intel® XMM™ 7360 LTE-Advanced (Cat9)¹⁵

Ethernet

Realtek RTL8111HSH-CG 10/100/1000 GbE NIC16

- 14. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.
- 15. WWAN module requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.
- 16. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



Technical Specifications

AUDIO/MULTIMEDIA

Audio

Integrated microphone (Mono or Dual Array)
2 Integrated stereo speakers

Camera

720p HD camera⁸
720p HD camera+IR Camera^{8,17}

8. HD content required to view HD images.

17. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant with optional backlit function

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

F1 - Display Switching

F2 - Blank

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Blank

F11 - Wireless

F12 - Sleep

Hidden Functions

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

SOFTWARE AND SECURITY

BIOS

HP BIOSphere Gen4¹⁸

HP DriveLock & Automatic DriveLock

BIOS Update via Network

Secure Erase¹⁹

Absolute Persistence Module²⁰



Technical Specifications

Pre-boot Authentication
HP Wireless Wakeup

Software

HP Native Miracast Support²¹

HP LAN-Wireless Protection

HP Connection Optimizer

HP 3D DriveGuard

HP Hotkey Support - CMIT

HP Jumpstart

HP Support Assistant²²

HP Noise Cancellation Software

HP PhoneWise²³

HP Host Based MAC Address Manager

Buy Office (sold separately)

Manageability Features

HP Driver Packs²⁴

HP System Software Manager (SSM)

HP BIOS Config Utility (BCU)

HP Client Catalog

HP Manageability Integration Kit Gen2²⁵

Ivanti Management Suite²⁶

Client Security Software

- HP Client Security Suite Gen4²⁷ including:
- HP Security Manager²⁸ (including Credential Manager, HP Password Manager, HP Spare Key)
- HP Fingerprint Sensor²⁹
- HP Device Access Manager³⁰
- HP Power On Authentication

Windows Defender³¹

Security Management

Secure Erase¹⁹

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)³²

SATA 0,1 port disablement (viaBIOS)

RAID configurations³³

Serial, USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Setup password (viaBIOS)

Support for chassis padlocks and cable lock devices



Technical Specifications

Integrated hood sensor HP Sure Click³⁴

- 18. HP BIOSphere Gen4 requires Intel(R) or AMD 8th Gen processors. Features may vary depending on the platform and configurations.
- 19. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method.
- 20. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 21. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming
- 22. HP Support Assistant requires Windows and Internet access.
- 23. HP PhoneWise Client is only available on select platforms. For supported platforms and HP PhoneWise system requirements see http://www.hp.com/go/HPPhoneWise.
- 24. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 25. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.
- 26. Ivanti Management Suite subscription required.
- 27. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.
- 28. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.
- 29. HP Fingerprint Sensor sold separately or as an optional feature.
- 30. HP Device Access Manager requires HP Client Security Suite Gen4.
- 31. Windows Defender Opt in and internet connection required for updates.
- 32. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).
- 33. RAID configuration is optional and does require a second hard drive.
- 34. HP Sure Click is available on most HP PCs and supports Microsoft® Internet Explorer and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode when Microsoft Office or Adobe Acrobat are installed.

POWER

Power Supply

HP Smart 65 W External AC power adapter³⁵
HP Smart 65 W EM External AC power adapter³⁵
HP Smart 65 W USB Type-C[™] adapter³⁵
HP Smart 45 W External AC power adapter³⁵
HP Smart 45 W USB Type-C[™] adapter³⁵

Primary Battery

3-cell, 45 Wh Long Life Li-ion³⁶



Technical Specifications

Battery Life

Up to 12 hours and 30 minutes 37

Power Cord

3-wire plug - 1m³⁵
3-wire plug - 1.8m³⁵
2-wire plug - 1m³⁵
Duckhead power cord- 1.0m³⁵
Duckhead power cord- 1.8m³⁵

Battery Weight

0.49 lb 0.22 kg

- 35. Availability may vary by country.
- 36. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 37. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Weight

Starting at 4.41 lbs³⁸ Starting at 2.0 kgs³⁸

Dimensions (w x d x h)

14.37 x 10.11 x 0.75 in 36.49 x 25.69 x 1.9 cm

38. Weight will vary by configuration.

PORTS/SLOTS

Ports

1 USB 3.1 Type-C[™] Gen 1 (Power delivery, DisplayPort[™]) 1 USB 2.0 (Powered port) 2 USB 3.1 1 HDMI 1.4b³⁹ 1 RJ-45 1 AC power 1 Headphone/microphone combo jack

Expansion Slots

1SD

Supports SD, SDHC, SDXC

39. HDMI cable sold separately.



Technical Specifications

SERVICE AND SUPPORT

HP Services offers 3-year and 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life Batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc. 40

40. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 19V
Average Operating Power Win 10
Integrated graphics 5.71W
Discrete Graphics 6.78W

Max Operating Power Discrete < 65W

UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C) Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

Random Vibration

Operating 0.75 grms
Non-operating 1.50 grms

Altitude (unpressurized)

Operating -50 to 10,000 ft (-15.24 to 3,048 m)

Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Planned Industry Standard

Certifications

UL Yes
CSA Yes
FCC Compliance Yes

Energy Star® Selected models 41

EPEAT Registered Gold in United States⁴²

Yes

Yes

ICES Yes Australia / Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes

Saudi Arabian Compliance (ICCP)



GOST

Technical Specifications

SABS Yes UKRSERTCOMPUTER Yes

- 41. Configurations of the HP ProBook 450 G6 that are ENERGY STAR® certified are identified as HP ProBook 450 G6 ENERGY STAR on HP websites and on http://www.energystar.gov.
- 42. EPEAT® registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options.

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 15.6 inch diagonal FHD (1920x1080) Anti-Glare WLED UWVA 45% cg 220nits eDP slim NB nontouch

 Outline Dimensions (W x H x D)
 350.96 x 216.75 (max.)

 Active Area
 344.16 x 193.59 (typ.)

Weight <370g max.

Diagonal Size 15.6"

Thickness 3.2mm max.

Interface eDP 1.2

Surface Treatment Anti-glare

Touch Enabled No

Contrast Ratio 600:1 (typ) - AG

Refresh Rate 60Hz

Brightness 220 nits typical (Panel Only)

Pixel Resolution 1920 x 1080 (FHD)

Format RGB
Backlight LED
Color Gamut Coverage 45%

Color Depth 6 bits + Hi FRC **Viewing Angle** UWVA 85/85/85/85

Panel LCD 15.6 inch diagonal HD (1366x768) Anti-Glare WLED SVA 45% cg 220nits eDP 1.2 w/o PSR slim NB non-touch

 Outline Dimensions (W x H x D)
 350.96 x 216.75 (max.)

 Active Area
 344.16 x 193.59 (typ.)

Weight <370g max.

Diagonal Size 15.6"

Thickness3.2mm max.InterfaceeDP 1.2Surface TreatmentAnti-glare



Technical Specifications

Touch Enabled No

Contrast Ratio 300:1 (typ)
Refresh Rate 60Hz

Brightness 220 nits typical (Panel Only)

Pixel Resolution 1366 x 768 (HD)

Format RGB
Backlight LED
Color Gamut Coverage 45%

Color Depth 6 bits + Hi FRC **Viewing Angle** SVA 40/40/15/30

Panel LCD 15.6 inch diagonal HD (1366x768) WLED SVA 45% cg 220nits eDP 1.2 w/o PSR slim NB touch Outline Dimensions (W x H x D) 350.96 x 216.75 (max.)

Active Area 344.16 x 193.59 (typ.)

Weight <568g max.

Diagonal Size 15.6"

Thickness 3.4mm max. **Interface** eDP 1.2

Surface Treatment BrightView Glass

Touch Enabled Yes

Contrast Ratio 300:1 (typ)
Refresh Rate 60Hz

Brightness 220 nits typical (Panel Only)

Pixel Resolution 1366 x 768 (HD)

Format RGB
Backlight LED
Color Gamut Coverage 45%

Color Depth 6 bits + Hi FRC **Viewing Angle** SVA 40/40/15/30

STORAGE AND DRIVES

Hard Drives

500 GB 7200 rpm SATA Hard Drive **Drive Weight** 0.20 lbs (92 g) ~ 0.21 lbs (95 g)

Rotation speed7200 rpmCache BufferUp to 32 MBHeight0.28 in (7 mm)Width2.75 in (69.85 mm)InterfaceATA-8, SATA 3.0Transfer Rate600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms;

Average: 11 ~ 13 ms;



Technical Specifications

Maximum: 18 ~ 22 ms

Logical Blocks 976,773,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp]

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

1 TB 5400 rpm SATA Hard

Drive

Drive Weight0.21 lbs (94 g)Rotation speed5400 rpmCache BufferUp to 32 MBHeight0.28 in (7.2 mm)Width2.75 in (69.85 mm)InterfaceATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track2 ms

Average12 ~ 13 ms Maximum18 ~ 22 ms

Logical Blocks 1,953,525,168

Operating Temperature 32° to 140° F (0° to 60° C) [top cover temp]

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

SSD 128 GB 2280 M2 SATA- Form Factor

3 TLC

Form Factor M.2 2280
Capacity 128GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 ATA-8, SATA 3.0

 Maximum Sequential Read
 Up To 520 MB/s

 Maximum Sequential Write
 Up To 450 MB/s

 Logical Blocks
 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

256 GB 2280 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp To 1700 MB/s



Technical Specifications

Maximum Sequential Write Up To 1300 MB/s Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

512 GB 2280 M2 PCIe NVMe Form Factor **TLC Solid State Drive** Capacity

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3X4
Maximum Sequential Read Up To 2600 MB/s
Maximum Sequential Write Up To 1400 MB/s
Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

16 GB 2280 PCIe-3x2 NVMe Form Factor 3D Xpoint Solid State Drive Capacity

Form Factor M.2 2280
Capacity 16 GB
NAND Type Xpoint

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X2

Maximum Sequential Read1400Maximum Sequential Write300

Logical Blocks 28,181,188

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features L1.2



Technical Specifications

NETWORKING/COMMUNICATIONS

Advanced CAT91

Intel® XMM™ 7360 LTE- Technology/Operating

bands

FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower). 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30),

1700/2100 (Band 66).

TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41).

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

Wireless protocol standards

3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to

450Mbps: UL 20MHz throughput up to 50Mbps

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone, A-GPS (MS-A, MS-B)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz

Maximum data rates LTE: 450 Mbps (Download), 50 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

Maximum output power

LTE: 23 dBm HSPA+: 23.5 dBm

Maximum power consumption

LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 5.8 q

Dimensions 42 x 30 x 2.3 mm

(Length x Width x Thickness)

> WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

Intel® XMM™ 7262 LTE-Advanced DL CAT6¹

Technology/Operating

bands

FDD LTE: 2100 (Band 1), 1800 (Band 3), 850 (Band 5), 2600 (Band 7), 900

(Band 8), 800 (Band 20), 700 (Band 28),

HSPA+: 2100 (Band 1), 850 (Band 5), 900 (Band 8)

Wireless protocol standards

3GPP Release 11 LTE Specification CAT.6. DL 40MHz BW throughput up to

300Mbps; UL 20MHz throughput up to 50Mbps

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

GPS Standalone, A-GPS (MS-A, MS-B and XTRA)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz

Maximum data rates LTE: 300 Mbps (Download), 50 Mbps (Upload)

> DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)

LTE: 23 dBm Maximum output power

HSPA+: 23.5 dBm

LTE: 1,200 mA (peak); 830 mA (average) **Maximum power** consumption HSPA+: 1,100 mA (peak); 680 mA (average)



Technical Specifications

Form Factor M.2, 3042-S3 Key B

Weight 6 g

Dimensions 42 x 30 x 2.3 mm

(Length x Width x Thickness)

> 1. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

WLAN

Intel® 9560 802.11a/b/g/n/ac (2x2) WLAN and Bluetooth® 5.0 Combo¹ non-vPro

Wireless LAN Standards

IEEE 802.11a IEEE 802.11b IEEE 802.11q IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability **Frequency Band** Wi-Fi® certified 802.11b/g/n

• 2.402 - 2.482 GHz

802.11a/n/ac

 4.9 – 4.95 GHz (Japan) • 5.15 - 5.25 GHz • 5.25 - 5.35 GHz • 5.47 - 5.725 GHz • 5.825 - 5.850 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11q: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, , 80MHz &

160MHz)

Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³

- IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI



Technical Specifications

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +18.5dBm minimum

802.11g: +17.5dBm minimum802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum

802.11ac VHT160(5GHz): +11.5dBm minimum

Power Consumption Transmit mode: 2.0 W

Receive mode: 1.6 W

Idle mode (PSP)180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

Dimensions 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Amber – Radio OFF; LED White – Radio ON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).



Technical Specifications

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

Bluetooth® Specification 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)

Channels

Signaling Data Rate

Legacy: 3 Mbps signaling data rate1

BLE: 1 Mbps signaling data rate1 1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Bluetooth Software

Supported **Link Topology** Microsoft Windows Bluetooth Software

Power Management

Certifications

Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management

Certifications

ETS 300 328, ETS 300 826

Low Voltage Directive IEC950UL, CSA, and CE Mark

Bluetooth Profiles

Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping

LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Realtek 802.11a/b/q/n/ac (2x2) WLAN and Bluetooth® 4.1 Combo¹

Wireless LAN Standards IEEE 802.11a IEEE 802.11b

IEEE 802.11q IEEE 802.11n IEEE 802.11ac

c06142921 — DA 16312 - Worldwide — Version 01 — November 12, 2018

Not all configuration components are available in all regions/countries.



Technical Specifications

Interoperability Wi-Fi® certified **Frequency Band** 802.11b/g/n

• 2.402 - 2.482 GHz

802.11a/n/ac

4.9 – 4.95 GHz (Japan)
5.15 – 5.25 GHz
5.25 – 5.35 GHz
5.47 – 5.725 GHz
5.825 – 5.850 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

• IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/g

mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Roaming

Infrastructure (Access Point Required)
IEEE 802.11 compliant roaming between access points

Output Power²

• 802.11b: +14dBm minimum

• 802.11g: +12dBm minimum

802.11a: +12dBm minimum
802.11n HT20(2.4GHz): +12dBm minimum

802.11n HT40(2.4GHz): +12dBm minimum
802.11n HT20(5GHz): +10dBm minimum
802.11n HT40(5GHz): +10dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption

Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10 mW Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum



Technical Specifications

802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Weight Type 2230: 2.8g **Operating Voltage** 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Amber – Radio OFF; LED White – Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1 Wireless Technology

Bluetooth Specification 4.0/4.1 Compliant
Frequency Band 2402 to 2480 MHz
Number of Available Legacy: 0∼79 (1 MHz/CH)

Channels

BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate¹

BLE: 1 Mbps signaling data rate¹
1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW Selective Suspend 17 mW

Electrical Interface USB 2.0 compliant

Bluetooth Software

Supported Link Topology Microsoft Windows Bluetooth Software

Power Management Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249



Technical Specifications

Power Management Certifications ETS 300 328, ETS 300 826 Low Voltage Directive IEC9

BT4.1-ESR 5/6/7 Compliance

Low Voltage Directive IEC950UL, CSA, and CE Mark

Bluetooth Profiles Supported

LE Link Layer Ping LE Dual Mode

LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

Realtek

802.11a/b/g/n/ac (1x1) WLAN and Bluetooth® 4.2 Combo¹ **Wireless LAN Standards**

IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac Wi-Fi certified

Interoperability Frequency Band

802.11b/g/n • 2.402 – 2.482 GHz

802.11a/n

4.9 – 4.95 GHz (Japan)
5.15 – 5.25 GHz
5.25 – 5.35 GHz
5.47 – 5.725 GHz
5.825 – 5.850 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

• 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³

- IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI



Technical Specifications

Network Architecture Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +14dBm minimum

802.11g: +12dBm minimum802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum
802.11n HT40(2.4GHz): +12dBm minimum
802.11n HT20(5GHz): +10dBm minimum
802.11n HT40(5GHz): +10dBm minimum
802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10 mW Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity³ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Weight Type 2230: 2.8g Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

HumidityOperating
Non-operating
Operating
10% to 90% (non-condensing)
5% to 95% (non-condensing)

Then operating 570 to 5570 (non-contact)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED White – Radio ON

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/q (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology



Technical Specifications

Bluetooth Specification 4.0

Frequency Band

Number of Available

Channels

Signaling Data Rate

4.0/4.1/4.2 Compliant 2402 to 2480 MHz

Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)

ate Legacy: 3 Mbps signaling data rate¹

BLE: 1 Mbps signaling data rate¹
1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

USB 2.0 compliant

Selective Suspend 17 mW

Electrical Interface

Bluetooth Software

Supported Link Topology Microsoft Windows Bluetooth Software

Microsoft Windows ACPI, and USB Bus Support

Power Management

Certifications

FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826

Power Management

Certifications

Bluetooth Profiles

Supported

Low Voltage Directive IEC950UL, CSA, and CE Mark

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode

LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full

LE Privacy 1.2 –Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

POWER

HP 45W Smart AC adapter Dimensions (H x W x D) 3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)

Weight 0.386 lb (175g) max



Technical Specifications

Input 90 to 265 VAC

Input Efficiency 87.74% at 115Vac and 88.4% at 230Vac

Input frequency range 47 to 63 Hz
Input AC current 1.4 A at 90 VAC

Output Output power 45W

DC output 19.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <8.0A

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating 32° F to 95° F (0° to 35° C)

temperature

Non-operating (storage) -4° F to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Smart AC adapter Dimensions 90x51x28.5mm

Weight unit: 220g +/- 10g

Input Input Efficiency 88% min at 115 VAC and 89% min at 230 VAC

Input frequency range 47 to 63 Hz
Input AC current 1.7 A at 90 VAC

Output Output power 65W

DC output 19.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <11.0A

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity20% to 95%Storage Humidity10% to 95%



Technical Specifications

EMI and Safety Certifications

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class 1. SELV: Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B.

FCC Class B. CISPR22 Class B. CCC. NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W EM Smart AC adapter

Dimensions 102x55x30mm Weight 270g +/- 10g

Input **Input Efficiency** 87% min at 115V/230V

> Input frequency range 47 to 63 Hz

1.7 A at 90 VAC and maximum load **Input AC current**

DC output 65W(19.5V/3.33A) Hold-up time 5 msec at 115 VAC input

Output current limit <11A, Over voltage protection- 29V max

automatic shutdown

Connector

4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design

Operating temperature 0° to 35° C

Non-operating (storage) -20° to 85° C

temperature

Altitude 0 to 5.000 m **Humidity** 0% to 95% **Storage Humidity** 0% to 95%

EMI and Safety Certifications

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1. SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B. CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Dimensions **USB** type C

Weight Input

74x74x28.5mm unit: 245q +/- 10q

Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range 47 to 63 Hz

Input AC current 1.7 A at 90 VAC and maximum load

65W **Output power**

DC output 5V/9V/10V/12V/15V/20V Hold-up time 5ms at 115 Vac input



Technical Specifications

Output current limit <8.0A

Type C Connector

Environmental Design **Operating** 0° to 35° C

temperature

Non-operating (storage) -20° to 85° C

temperature

Altitude 0 to 5.000 m **Humidity** 0% to 95% **Storage Humidity** 0% to 95%

EMI and Safety Certifications

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200.000 hours at 25°C ambient condition.

AC Adapter 45 Watt nPFC Dimensions **USB** type C

Weight

Input

62.0x62.0x28.5mm

unit: 220g +/- 10g

Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:5V: 81.5%9V: 86.7%10V: 87.5%12V: 87.8%15V:

87.8%20V: 87.8%

Input frequency range 47 to 63 Hz

Input AC current Max. 1.4 A at 90 Vac

Output power 5V/15W

> 9V/27W 10V/37.5W 12V/45W 15V/45W 20V/45W

DC output 5V/9V/10V/12V/15V/20V

Hold-up time 5ms at 115 Vac input

Output current limit <5.0A

Connector Type C

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16.400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications

*CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.



Technical Specifications

* MTBF - over 200,000 hours at 25°C ambient condition.

3 Cell WHr 45 Long Life -Polymer HP Fast Charge Technology¹ **Dimensions (H x W x L)** 6.0. x184.7x88.9 mm

Weight 0.22 kg (0.48lb)
Cells/Type 3cell Lithium-Ion

Voltage 11.55V Amp-hour capacity 3.900Ah Watt-hour capacity 45Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

1. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA
	HP Essential Backpack	H1D24AA
	HP Essential Messenger Case	H1D25AA
Dockings	HP USB-C Mini Dock	1PM64AA
	HP USB-C Universal Dock	1MK33AA
	HP USB-C Dock G4	3FF69AA
Input/Output	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP HDMI to DVI Adapter	F5A28AA
Memory	4GB 2666MHz DDR4	4VN05AA
	8GB 2666MHz DDR4	4VN06AA
	16GB 2666 MHz DDR4	4VN07AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 65W USB-C Power Adapter	3PN48AA
	HP 45W USB-C Power Adapter	1HE17AA
	HP 65W USB-C Power Adapter	1HE08AA
	HP Power Bank	N9F71AA
	HP USB-C Power Bank	2NA10AA
	HP 45W LC USB-C Power Adapter	1MZ01AA#ABA
Storage	HP External USB Optical Drive	F2B56AA
	HP 500GB 7200rpm HDD	F3B97AA
Security	HP Combination Lock	TOY15AA
	HP Essential Keyed Cable lock 12.3mm	TOY14AA
	HP Keyed Cable Lock 10mm	T1A62AA
	HP UltraSlim Keyed Cable Lock	T1A62AA
UCC	HP Conferencing Keyboard	K8P74AA
	HP Speaker Phone	K7V16AA
	HP Wired Headset	K7V17AA
Displays	HP ProDisplay P223 21.5-inch Monitor	X7R61AA
	HP ProDisplay P232 23-inch Monitor	K7X31AA
	HP ProDisplay P240va 23.8-inch Monitor	X3B48AA
	HP EliteDisplay E243 23.8-inch Monitor	1FH47AA
	HP EliteDisplay E243m 23.8-inch Collaboration Monitor	1FH48AA
	HP EliteDisplay E273 27-inch Monitor	1FH50AA



HP ProBook 450 G6 Notebook PC

QuickSpecs

Summary of Changes

Date of change:	Version History:	Description of change:
	V1 to V2	

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